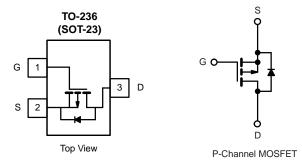


P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)	
	0.030 at V _{GS} = - 10 V	- 5.6		
- 30	0.033 at V _{GS} = - 6 V	- 5	11.4 nC	
	0.038 at V _{GS} = - 4.5 V	-4.5		



FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g Tested



APPLICATIONS

- For Mobile Computing
 - Load Switch
 - Notebook Adaptor Switch
 - DC/DC Converter

40

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V _{DS}	- 30	V
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C		- 5.6	
Continuous Drain Current (T. 450 °C)	T _C = 70 °C		- 5.1	
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	- I _D	- 5.4 ^{b,c}	
	T _A = 70 °C		- 4.3 ^{b,c}	A
Pulsed Drain Current (t = 100 µs)		I _{DM}	- 18	
Continous Source-Drain Diode Current	T _C = 25 °C	- I _S	- 2.1	
Continous Source-Drain Diode Current	T _A = 25 °C		- 1 ^{b,c}	
	T _C = 25 °C		2.5	
Maximum Power Dissipation	T _C = 70 °C		1.6	W
	T _A = 25 °C	P _D	1.25 ^{b,c}	VV
	T _A = 70 °C		0.8 ^{b,c}	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C

 $\mathsf{R}_{\mathsf{thJF}}$

THERMAL RESISTANCE RATINGSParameterSymbolTypicalMaximum Junction-to-Ambient^{b,d} $t \le 5 s$ R_{thJA} 75

- Maximum Junction-to-Foot (Drain) Steady State
 Notes:
- a. Based on $T_C = 25 \ ^{\circ}C$.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under steady state conditions is 166 $^{\circ}\text{C/W}.$

Unit

°C/W

Maximum

100

50

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www.V	/Bsemi.com

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-				1	1	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	1 0504		- 19		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		4			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zana Oala Mallana Daria Oanad	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$			- 5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	- 2.5			Α	
		V _{GS} =- 10 V, I _D = - 4.4 A		0.030		Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} =- 6 V, I _D = - 4 A		0.033			
		V _{GS} =- 4.5 V, I _D = - 3.6 A		0.038			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 3.4 A		18		S	
Dynamic ^b		•		•	•	•	
Input Capacitance	C _{iss}			1295			
Output Capacitance	C _{oss}	V _{DS} = - 15 V, V _{GS} = 0 V, f = 1 MHz		150		pF	
Reverse Transfer Capacitance	C _{rss}			130			
Takal Qaka Okasu	Q _g Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 10 V, I_{D} = - 5.4 A		24	36	nC	
Total Gate Charge				11.4	17		
Gate-Source Charge		V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 5.4 A		3.4			
Gate-Drain Charge	Q _{gd}			3.8			
Gate Resistance	Rg	f = 1 MHz	1.5	7.7	15.4	Ω	
Turn-On Delay Time	t _{d(on)}			13	20		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 3.5 Ω		4	8		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 4.3 A, V_GEN = - 10 V, R_g = 1 Ω		38	57	1	
Fall Time	t _f			6	12		
Turn-On Delay Time	t _{d(on)}			28	42	ns	
Rise Time t _r		V_{DD} = - 15 V, R_L = 3.5 Ω		16	24]	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 4.3 A, V_GEN = - 4.5 V, R_g = 1 Ω		30	45		
Fall Time	t _f			10	20		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			- 2.1	A	
Pulse Diode Forward Current (t = $100 \mu s$)	I _{SM}				- 80	~	
Body Diode Voltage	V _{SD}	$I_{S} = -4.3 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	23	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 4.3 A, dl/dt = 100 A/μs, T _J = 25 °C		7	14	nC	
Reverse Recovery Fall Time	t _a	$r_{\rm F} = -4.5$ A, $u/u_{\rm C} = 100$ A/µs, $r_{\rm J} = 25$ °C		8		ns	
Reverse Recovery Rise Time	t _b	1 1		7			

Notes:

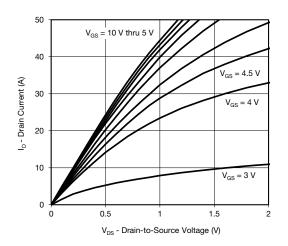
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

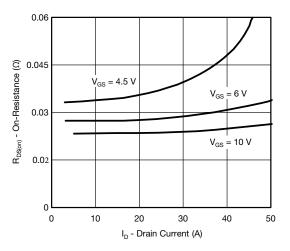
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



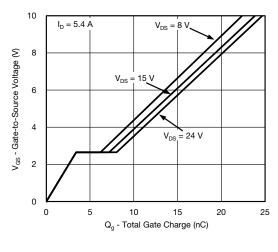




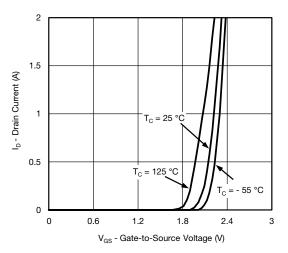
Output Characteristics



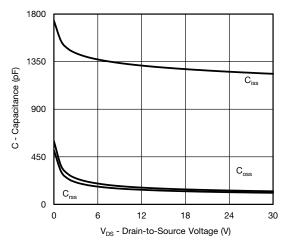
On-Resistance vs. Drain Current



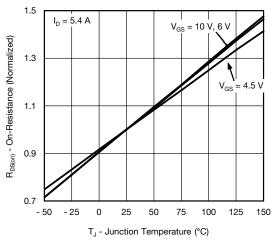
Gate Charge



Transfer Characteristics

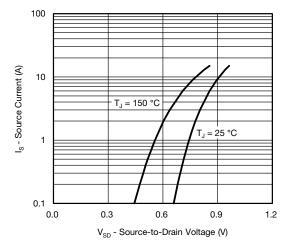


Capacitance

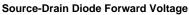


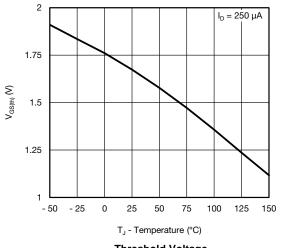
On-Resistance vs. Junction Temperature



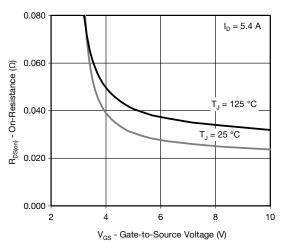


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

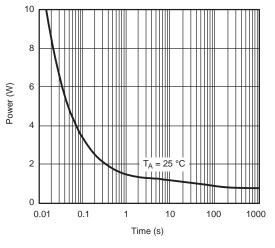




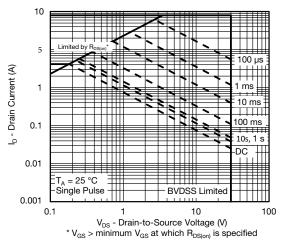
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



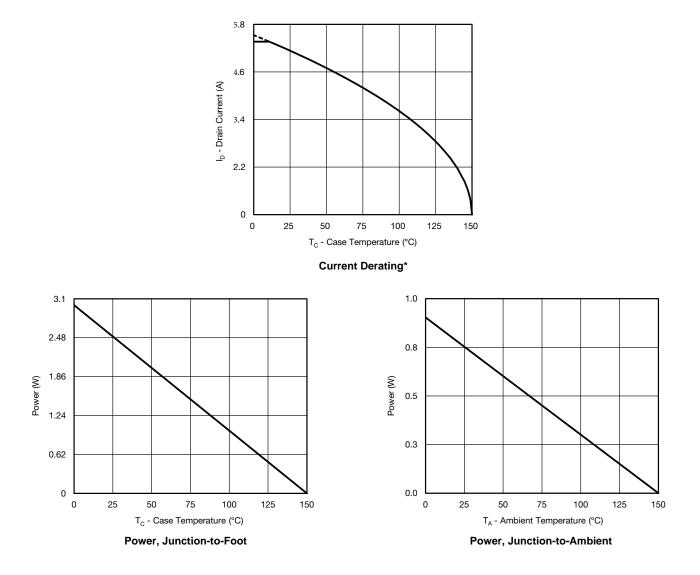
Single Pulse Power (Junction-to-Ambient)



Safe Operating Area, Junction-to-Ambient



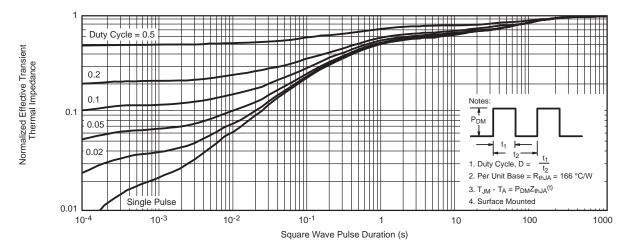
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



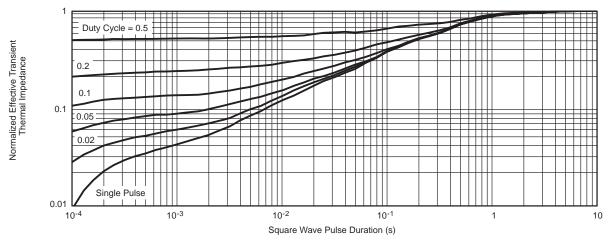
* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

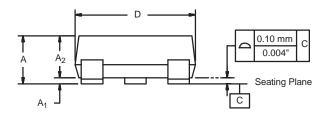


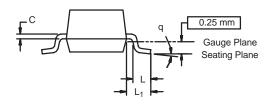
Normalized Thermal Transient Impedance, Junction-to-Foot



SOT-23 (TO-236): 3-LEAD



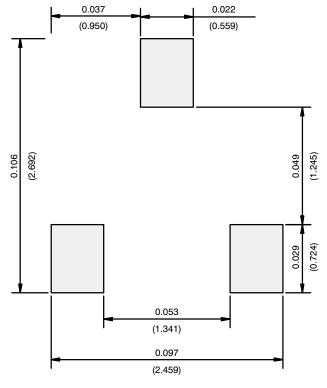




Dim	MILLIMETERS		INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
C	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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